

DATA SHEET



BYD77 series

Ultra fast low-loss controlled avalanche rectifiers

Product specification
Supersedes data of 1996 May 24

1999 Nov 15

Ultra fast low-loss controlled avalanche rectifiers

BYD77 series

FEATURES

- Glass passivated
- High maximum operating temperature
- Low leakage current
- Excellent stability
- Guaranteed avalanche energy absorption capability
- Shipped in 8 mm embossed tape
- Smallest surface mount rectifier outline.

DESCRIPTION

Cavity free cylindrical glass SOD87 package through Implotec™⁽¹⁾ technology. This package is

hermetically sealed and fatigue free as coefficients of expansion of all used parts are matched.

(1) Implotec is a trademark of Philips.

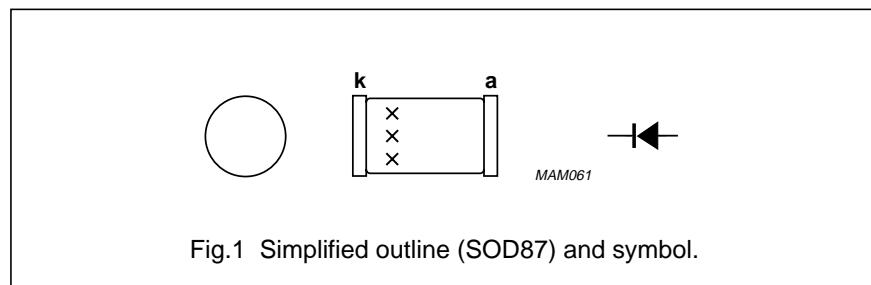


Fig.1 Simplified outline (SOD87) and symbol.

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_{RRM}	repetitive peak reverse voltage BYD77A BYD77B BYD77C BYD77D BYD77E BYD77F BYD77G		—	50	V
V_R	continuous reverse voltage BYD77A BYD77B BYD77C BYD77D BYD77E BYD77F BYD77G		—	100	V
$I_{F(AV)}$	average forward current BYD77A to D BYD77E to G	$T_{tp} = 105^\circ\text{C}$; see Figs 2 and 3; averaged over any 20 ms period; see also Figs 10 and 11	—	2.00	A
$I_{F(AV)}$	average forward current BYD77A to D BYD77E to G	$T_{amb} = 60^\circ\text{C}$; PCB mounting (see Fig.16); see Figs 4 and 5; averaged over any 20 ms period; see also Figs 10 and 11	—	1.85	A
			—	0.85	A
			—	0.80	A

Ultra fast low-loss controlled avalanche rectifiers

BYD77 series

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
I_{FRM}	repetitive peak forward current BYD77A to D BYD77E to G	$T_{tp} = 105^\circ\text{C}$; see Figs 6 and 7	—	15	A
I_{FRM}	repetitive peak forward current BYD77A to D BYD77E to G	$T_{amb} = 60^\circ\text{C}$; see Figs 8 and 9	—	8.5	A
I_{FSM}	non-repetitive peak forward current	$t = 10 \text{ ms}$ half sine wave; $T_j = T_{j \max}$ prior to surge; $V_R = V_{RRM\max}$	—	25	A
E_{RSM}	non-repetitive peak reverse avalanche energy	$L = 120 \text{ mH}$; $T_j = 25^\circ\text{C}$ prior to surge; inductive load switched off	—	10	mJ
T_{stg}	storage temperature		-65	+175	°C
T_j	junction temperature		-65	+175	°C

ELECTRICAL CHARACTERISTICS $T_j = 25^\circ\text{C}$ unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V_F	forward voltage BYD77A to D BYD77E to G	$I_F = 1 \text{ A}$; $T_j = T_{j \max}$; see Figs 12 and 13	—	—	0.75	V
V_F	forward voltage BYD77A to D BYD77E to G	$I_F = 1 \text{ A}$; see Figs 12 and 13	—	—	0.98	V
$V_{(BR)R}$	reverse avalanche breakdown voltage BYD77A BYD77B BYD77C BYD77D BYD77E BYD77F BYD77G	$I_R = 0.1 \text{ mA}$	55 110 165 220 275 330 440	— — — — — — —	— — — — — — —	V
I_R	reverse current	$V_R = V_{RRM\max}$; see Fig.14	—	—	1	μA
		$V_R = V_{RRM\max}$; $T_j = 165^\circ\text{C}$; see Fig.14	—	—	100	μA
t_{rr}	reverse recovery time BYD77A to D BYD77E to G	when switched from $I_F = 0.5 \text{ A}$ to $I_R = 1 \text{ A}$; measured at $I_R = 0.25 \text{ A}$; see Fig.18	— —	— —	25 50	ns ns

Ultra fast low-loss controlled avalanche rectifiers

BYD77 series

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
C_d	diode capacitance BYD77A to D BYD77E to G	$f = 1 \text{ MHz}; V_R = 0 \text{ V};$ see Fig.15	—	50	—	pF
$\left \frac{dI_R}{dt} \right $	maximum slope of reverse recovery current BYD77A to D BYD77E to G	when switched from $I_F = 1 \text{ A}$ to $V_R \geq 30 \text{ V}$ and $dI_F/dt = -1 \text{ A}/\mu\text{s};$ see Fig.17	—	—	4	$\text{A}/\mu\text{s}$
			—	—	5	$\text{A}/\mu\text{s}$

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
$R_{th j\text{-tp}}$	thermal resistance from junction to tie-point		30	K/W
$R_{th j\text{-a}}$	thermal resistance from junction to ambient	note 1	150	K/W

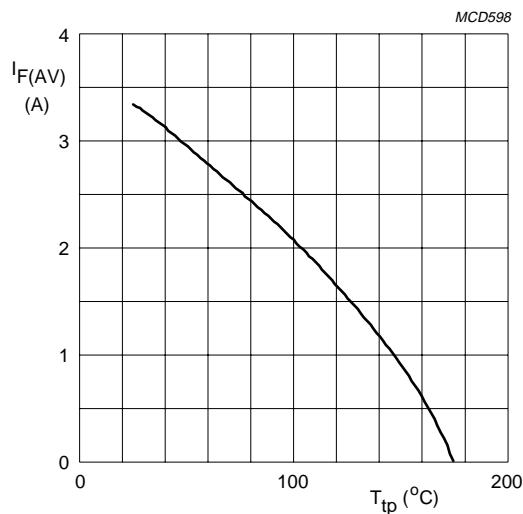
Note

1. Device mounted on an epoxy-glass printed-circuit board, 1.5 mm thick; thickness of Cu-layer $\geq 40 \mu\text{m}$, see Fig.16.
For more information please refer to the "General Part of associated Handbook".

Ultra fast low-loss controlled avalanche rectifiers

BYD77 series

GRAPHICAL DATA

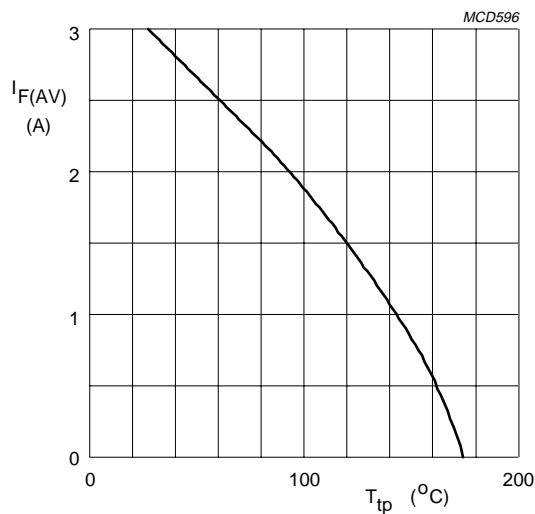


BYD77A to D

$a = 1.42$; $V_R = V_{RRMmax}$; $\delta = 0.5$.

Switched mode application.

Fig.2 Maximum permissible average forward current as a function of tie-point temperature (including losses due to reverse leakage).

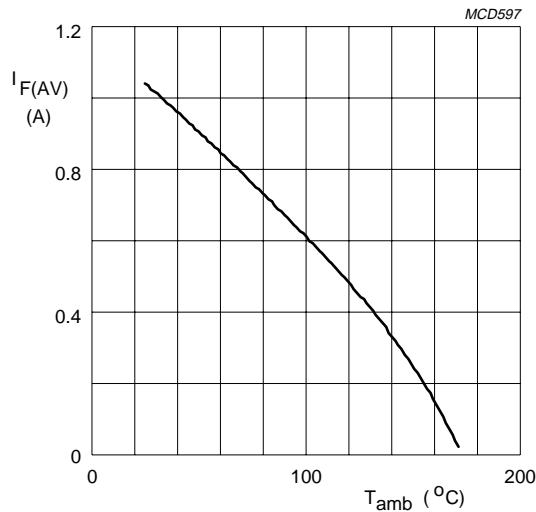


BYD77E to G

$a = 1.42$; $V_R = V_{RRMmax}$; $\delta = 0.5$.

Switched mode application.

Fig.3 Maximum permissible average forward current as a function of tie-point temperature (including losses due to reverse leakage).



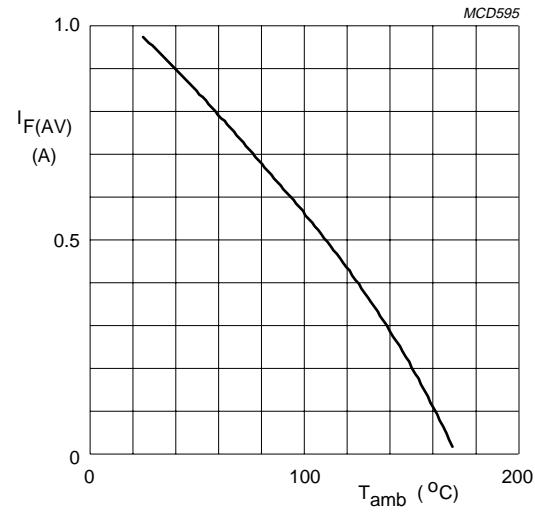
BYD77A to D

$a = 1.42$; $V_R = V_{RRMmax}$; $\delta = 0.5$.

Device mounted as shown in Fig.16.

Switched mode application.

Fig.4 Maximum permissible average forward current as a function of ambient temperature (including losses due to reverse leakage).



BYD77E to G

$a = 1.42$; $V_R = V_{RRMmax}$; $\delta = 0.5$.

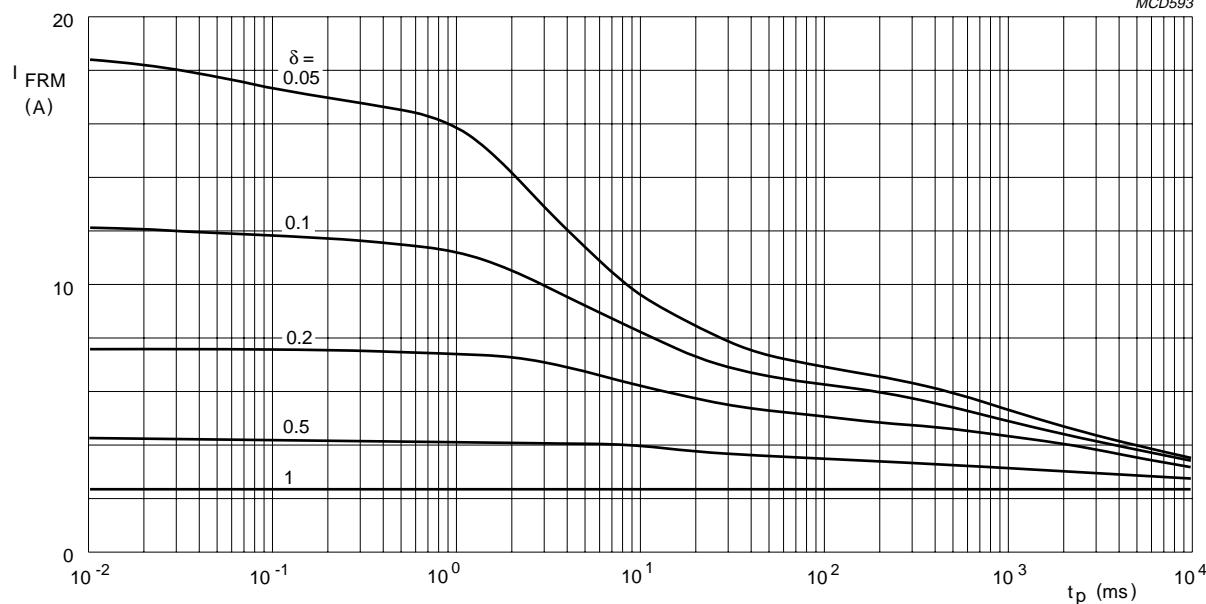
Device mounted as shown in Fig.16.

Switched mode application.

Fig.5 Maximum permissible average forward current as a function of ambient temperature (including losses due to reverse leakage).

Ultra fast low-loss controlled avalanche rectifiers

BYD77 series

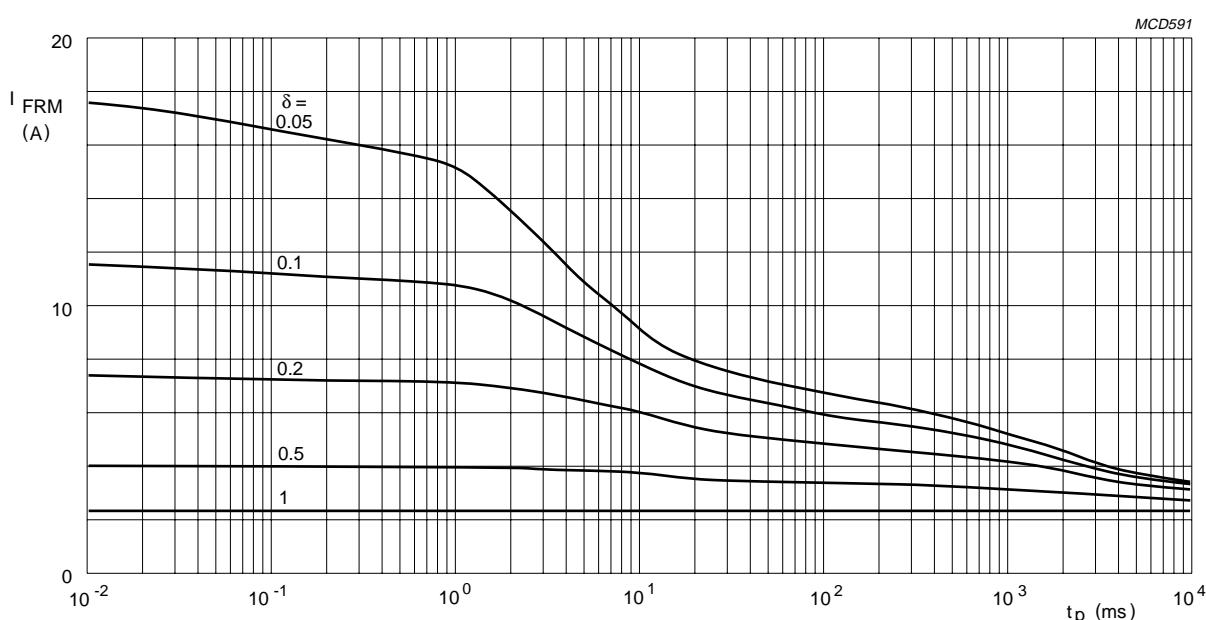


BYD77A to D

$T_{tp} = 105^\circ\text{C}$; $R_{th,j-tp} = 30 \text{ K/W}$.

V_{RRMmax} during $1 - \delta$; curves include derating for T_{jmax} at $V_{RRM} = 200 \text{ V}$.

Fig.6 Maximum repetitive peak forward current as a function of pulse time (square pulse) and duty factor.



BYD77E to G

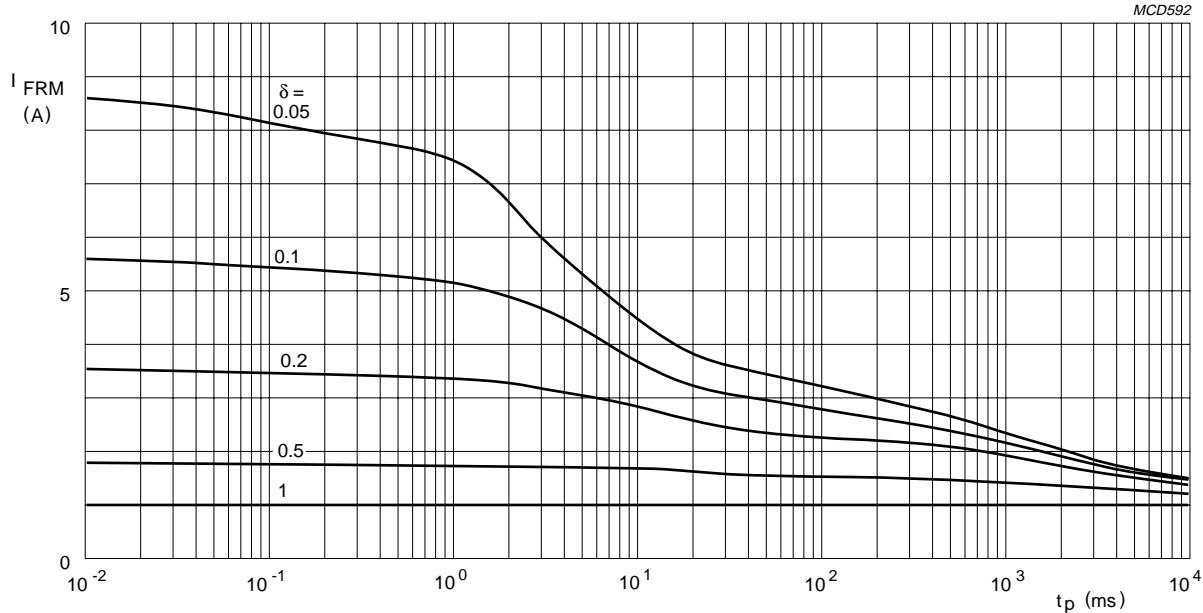
$T_{tp} = 105^\circ\text{C}$; $R_{th,j-tp} = 30 \text{ K/W}$.

V_{RRMmax} during $1 - \delta$; curves include derating for T_{jmax} at $V_{RRM} = 400 \text{ V}$.

Fig.7 Maximum repetitive peak forward current as a function of pulse time (square pulse) and duty factor.

Ultra fast low-loss controlled avalanche rectifiers

BYD77 series

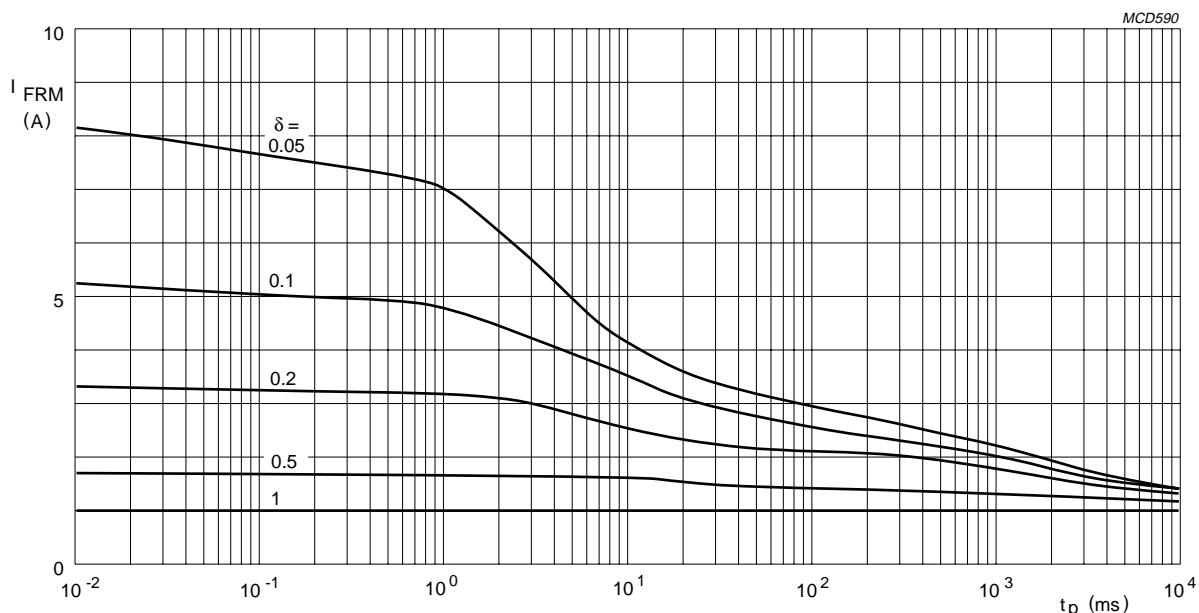


BYD77A to D

$T_{amb} = 60^\circ C$; $R_{th\ j-a} = 150 \text{ K/W}$.

V_{RRMmax} during $1 - \delta$; curves include derating for $T_{j\ max}$ at $V_{RRM} = 200 \text{ V}$.

Fig.8 Maximum repetitive peak forward current as a function of pulse time (square pulse) and duty factor.



BYD77E to G

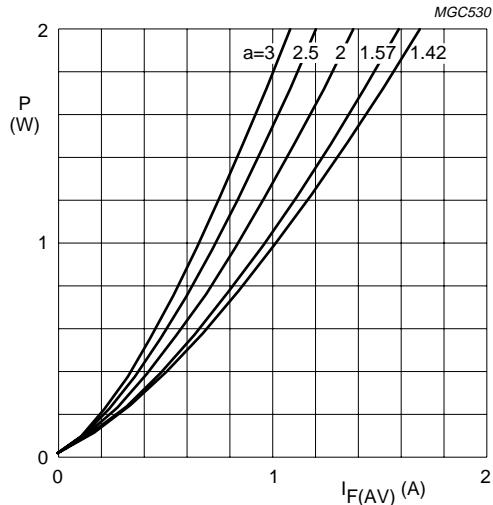
$T_{amb} = 60^\circ C$; $R_{th\ j-a} = 150 \text{ K/W}$.

V_{RRMmax} during $1 - \delta$; curves include derating for $T_{j\ max}$ at $V_{RRM} = 400 \text{ V}$.

Fig.9 Maximum repetitive peak forward current as a function of pulse time (square pulse) and duty factor.

Ultra fast low-loss controlled avalanche rectifiers

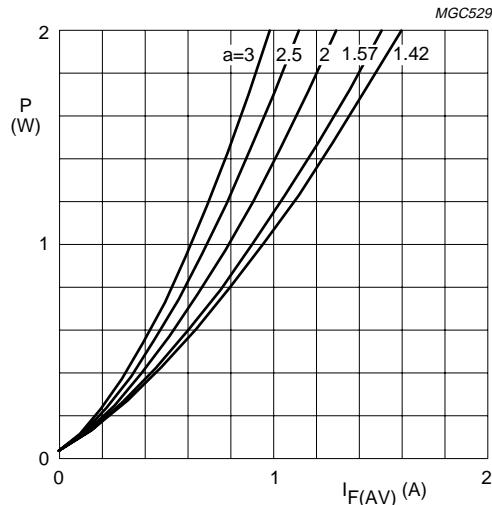
BYD77 series



BYD77A to D

$$a = I_{F(RMS)}/I_{F(AV)}; V_R = V_{RRMmax}; \delta = 0.5.$$

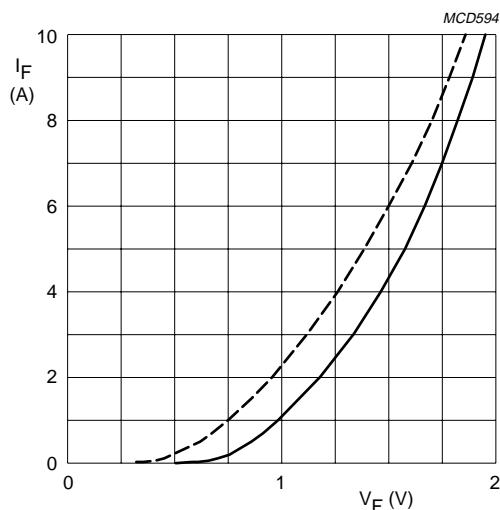
Fig.10 Maximum steady state power dissipation (forward plus leakage current losses, excluding switching losses) as a function of average forward current.



BYD77E to G

$$a = I_{F(RMS)}/I_{F(AV)}; V_R = V_{RRMmax}; \delta = 0.5.$$

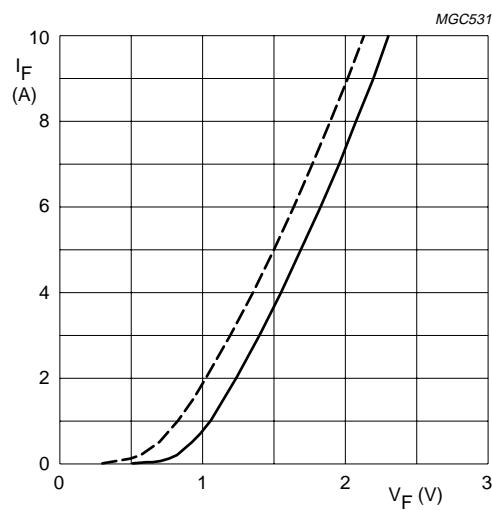
Fig.11 Maximum steady state power dissipation (forward plus leakage current losses, excluding switching losses) as a function of average forward current.



BYD77A to D

Dotted line: $T_j = 175^\circ\text{C}$.
Solid line: $T_j = 25^\circ\text{C}$.

Fig.12 Forward current as a function of forward voltage; maximum values.



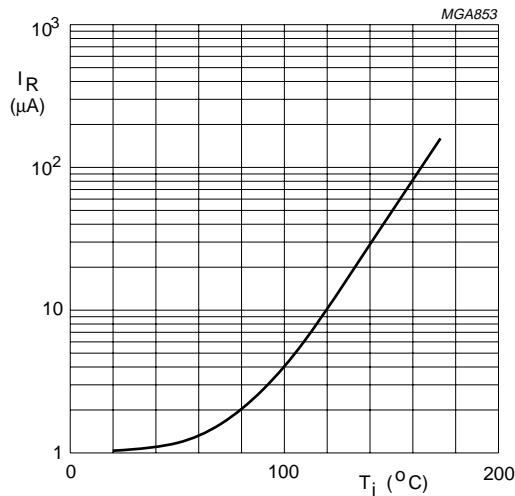
BYD77E to G

Dotted line: $T_j = 175^\circ\text{C}$.
Solid line: $T_j = 25^\circ\text{C}$.

Fig.13 Forward current as a function of forward voltage; maximum values.

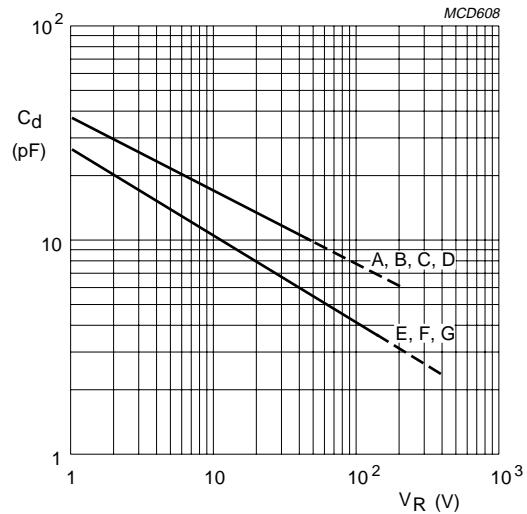
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BYD77 series



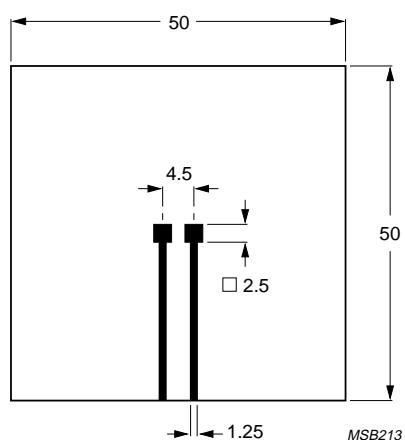
$V_R = V_{RRMmax}$.

Fig.14 Reverse current as a function of junction temperature; maximum values.



$f = 1 \text{ MHz}; T_j = 25 \text{ }^{\circ}\text{C}$.

Fig.15 Diode capacitance as a function of reverse voltage; typical values.



Dimensions in mm.

Fig.16 Printed-circuit board for surface mounting.

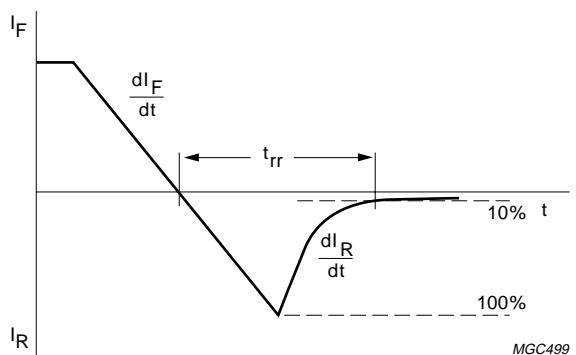
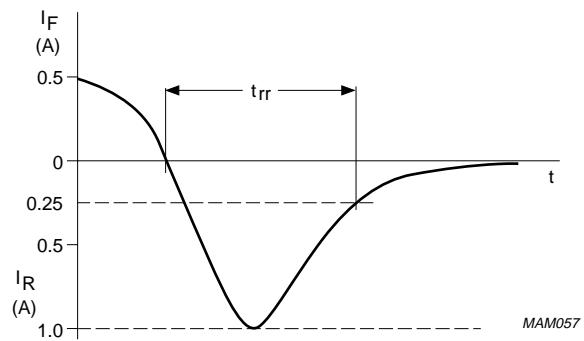
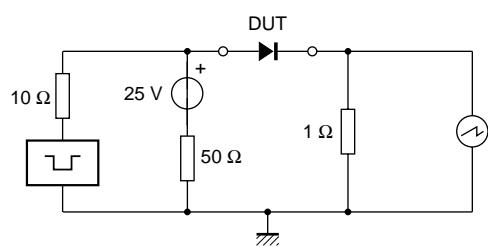


Fig.17 Reverse recovery definitions.

**Ultra fast low-loss
controlled avalanche rectifiers****BYD77 series**

Input impedance oscilloscope: $1 \text{ M}\Omega$, 22 pF ; $t_r \leq 7 \text{ ns}$.

Source impedance: $50 \text{ }\Omega$; $t_r \leq 15 \text{ ns}$.

Fig.18 Test circuit and reverse recovery time waveform and definition.

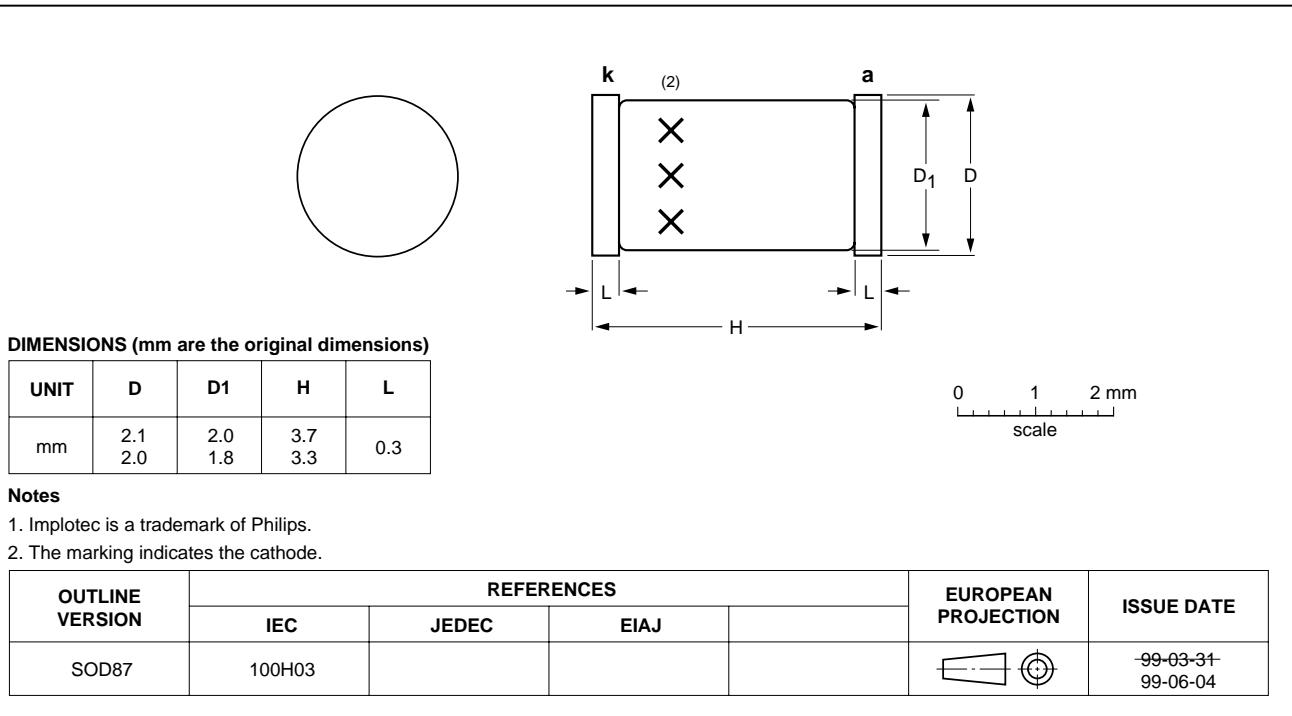
Ultra fast low-loss controlled avalanche rectifiers

BYD77 series

PACKAGE OUTLINE

**Hermetically sealed glass surface mounted package;
Implotec™⁽¹⁾ technology; 2 connectors**

SOD87



DEFINITIONS

Data Sheet Status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
Limiting values	
Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.	
Application information	
Where application information is given, it is advisory and does not form part of the specification.	

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